PRELIMINARY SPEC

#### 4.0x4.0mm RIGHT ANGLE SURFACE MOUNT LED LAMP

Part Number: KA-4040ZGC

Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

#### Features

- SINGLE COLOR.
- SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- IDEAL FOR BACKLIGHTING.
- PACKAGE : 500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

#### Description

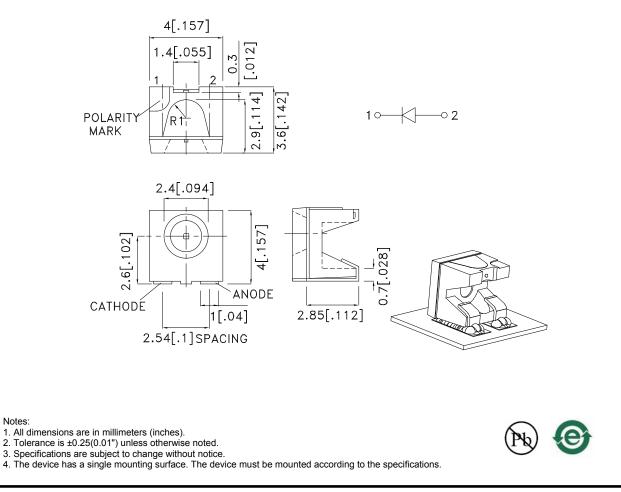
The Green source color devices are made with AlInGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

#### Package Dimensions



SPEC NO: DSAG4805 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: JUL/10/2007 DRAWN: Y.L.LI PAGE: 1 OF 4 ERP: 1201002289

#### **Selection Guide**

Part No.	Dice	Dice Lens Type Iv (mcd) [2] @ 20mA		/ <b>-</b> -	Viewing Angle [1]
			Min.	Тур.	201/2
KA-4040ZGC	Green (AllnGaN)	WATER CLEAR	480	800	90°

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

2. Luminous intensity/ luminous Flux: +/-15%.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Тур. Мах.		Test Conditions	
λpeak	Peak Wavelength	Green	515		nm	I⊧=20mA	
λD [1]	Dominant Wavelength	Green	525		nm	I⊧=20mA	
Δλ1/2	Spectral Line Half-width	Green	30		nm	I⊧=20mA	
С	Capacitance	Green	45		pF	VF=0V;f=1MHz	
VF [2]	Forward Voltage	Green	3.3	4.1	V	I⊧=20mA	
lr	Reverse Current	Green		10	uA	Vr=5V	

Notes:

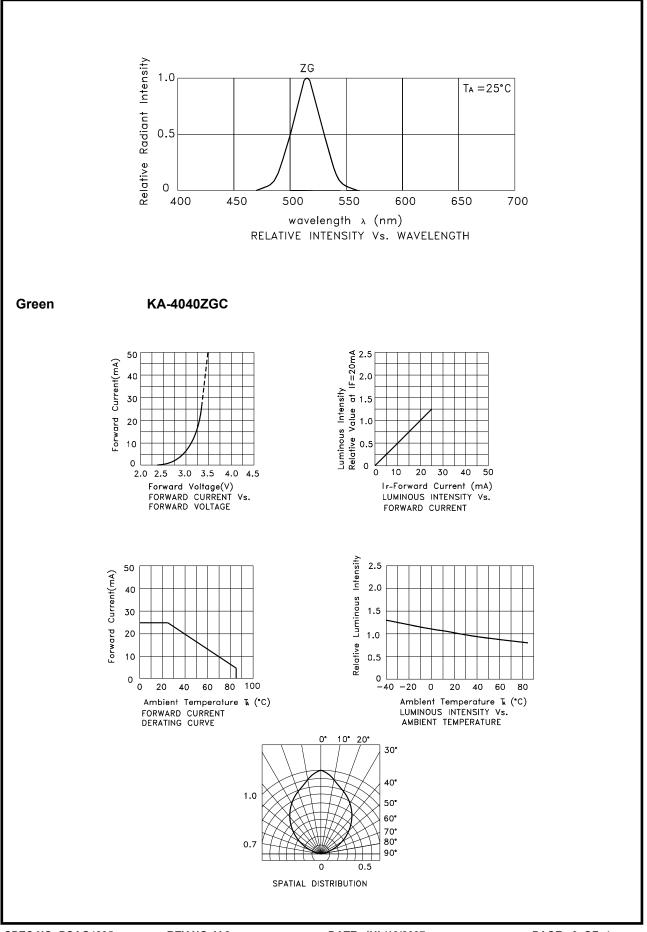
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

#### Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units	
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

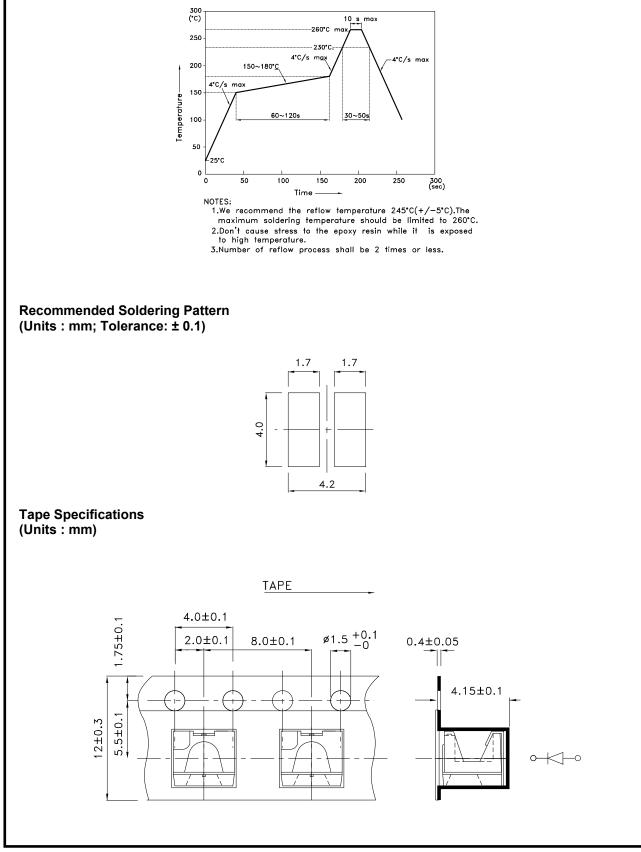
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.





Reflow Soldering Profile For Lead-free SMT Process.



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